IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplie	r Information														
Company name* Compan				npany unique ID			Unique ID Authority					Response Date*			
onsemi												2024-05-17			
Contact N	lame	Title - Contact]	Phone - Contact*					Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorize	ed Representative*	Title - Representative]	Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	ve Date Version Manufacturing Si		ring Site	Weight*		UOM	Unit Type	
		SB5100		5A 100V SCHOTTKY RECT			2024-05-17			PANJITFG		1	122.0182	mg	Each
Manufa	cturing Proccess Informat	tion												, 	,
	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-STD-020 MS		-STD-020 MSL	Rating	Peak Pro	Peak Process Body Temperatu		ure Max Time at Peak Temper		Temperati	ure Numb	ber of Reflow Cyc	eles
	Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30 seco		second	ds 3				
Comments	3														
or more	information regarding material	compositi <u>on</u>	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shave provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.78	mg	Supplier	Silicon (Si)	7440-21-3		3.78	mg
Die Attach Solder	4.1195	mg	Supplier	Silver (Ag)	7440-22-4		0.103	mg
			A	Lead (Pb)	7439-92-1	7a	3.8105	mg
			Supplier	Tin (Sn)	7440-31-5		0.206	mg
Lead Wire	820.9194	mg	Supplier	Iron (Fe)	7439-89-6		0.6569	mg
			Supplier	Copper (Cu)	7440-50-8		820.0984	mg
			Supplier	Phosphorus (P)	7723-14-0		0.164	mg
Marking Ink	0.0231	mg	Supplier	Silicon Dioxide (SiO2)	112945-52-5		0.0012	mg
			Supplier	1-Hydroxycyclohexyl phenyl ketone	947-19-3		0.0012	mg
			Supplier	Padimate (C14H21NO2)	21245-01-2		0.0023	mg
			Supplier	2-Propenoic acid polymer	53192-18-0		0.015	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0035	mg
Mold Compound-Black	233.9	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		4.6774	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		58.4352	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		4.6774	mg
			Supplier	Carbon Black (C)	1333-86-4		2.3387	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		163.7713	mg
Plating	59.2762	mg	Supplier	Tin (Sn)	7440-31-5		59.2762	mg